


PRODUCT / PROCESS CHANGE INFORMATION

1. PCI basic data

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	EMBEDDED PROCESSING/26/16328	
1.3 Title of PCI	SPC58xNx (FG84): Activation of KESM as Additional Final Test and Burn-In Location for Parts Assembled in Malta Plant	
1.4 Product Category	see list	
1.5 Issue date	2026-04-30	

2. PCI Team

2.1 Contact supplier	
2.1.1 Name	ROBERTSON HEATHER
2.1.2 Phone	+1 8475853058
2.1.3 Email	heather.robertson@st.com
2.2 Change responsibility	
2.2.1 Product Manager	Patrick AIDOUNE
2.1.2 Marketing Manager	Emiliano Mario PICCINELLI
2.1.3 Quality Manager	Pascal NARCHE

3. Change

3.1 Category	3.2 Type of change	3.3 Manufacturing Location
Transfer	Line transfer for a full process or process brick (process step, control plan, recipes) from one site to another site: Testing (SOP 2617)	Subcon. KESM - Malaysia receiving Plant

4. Description of change

	Old	New
4.1 Description	ST Kirkop - Malta	ST Kirkop - Malta and Subcon. KESM - Malaysia
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No Impact	

5. Reason / motivation for change

5.1 Motivation	Service – Dual source & Capacity Improvement. Expansion of current testing capacity (volumes increase) and flexible/secure production asset – dual sourcing strategy.
5.2 Customer Benefit	DOUBLE SOURCING

6. Marking of parts / traceability of change

6.1 Description	Dedicated Finished Good Codes
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7. Timing / schedule

7.1 Date of qualification results	2026-04-27
7.2 Intended start of delivery	2026-08-01
7.3 Qualification sample available?	Upon Request

8. Qualification / Validation

8.1 Description	16328 Bernina6M_QFP176_KESM_FT_Qual_Report.zip		
8.2 Qualification report and qualification results	Available (see attachment)	Issue Date	2026-04-30

9. Attachments (additional documentations)

16328 Public product.pdf
16328 Details.pdf
16328 Bernina6M_QFP176_KESM_FT_Qual_Report.zip

10. Affected parts		
10.1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	SPC58NN84E7RMHBR	
	SPC58NN84E7RMHBY	

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